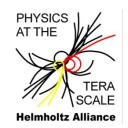


Development of a TPC for a Linear Collider

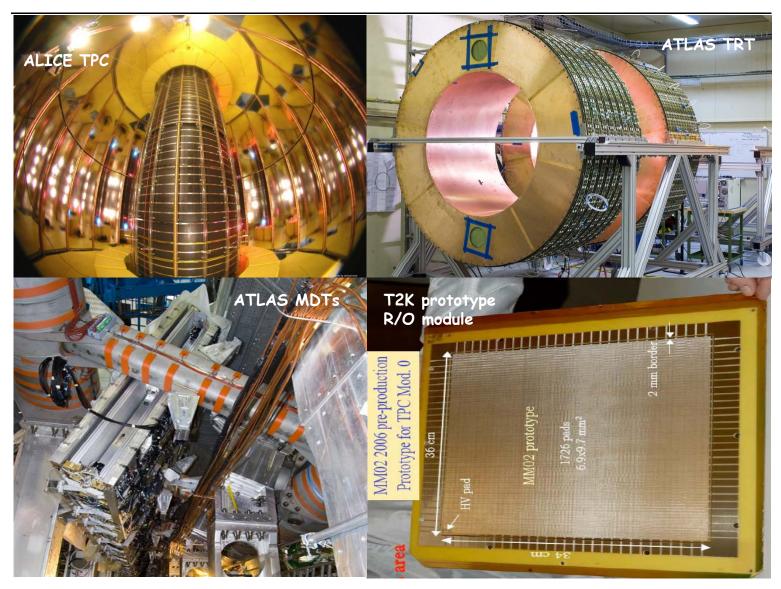
K. Desch • Universität Bonn • 04/04/2008 1st Detector Workshop of the Helmholtz-Alliance "Physics at the Terascale" Universität Karlsruhe







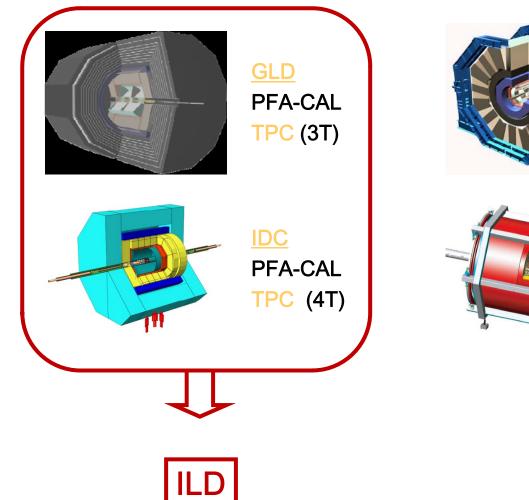
Gaseous detectors are not dead!



gas is thin...



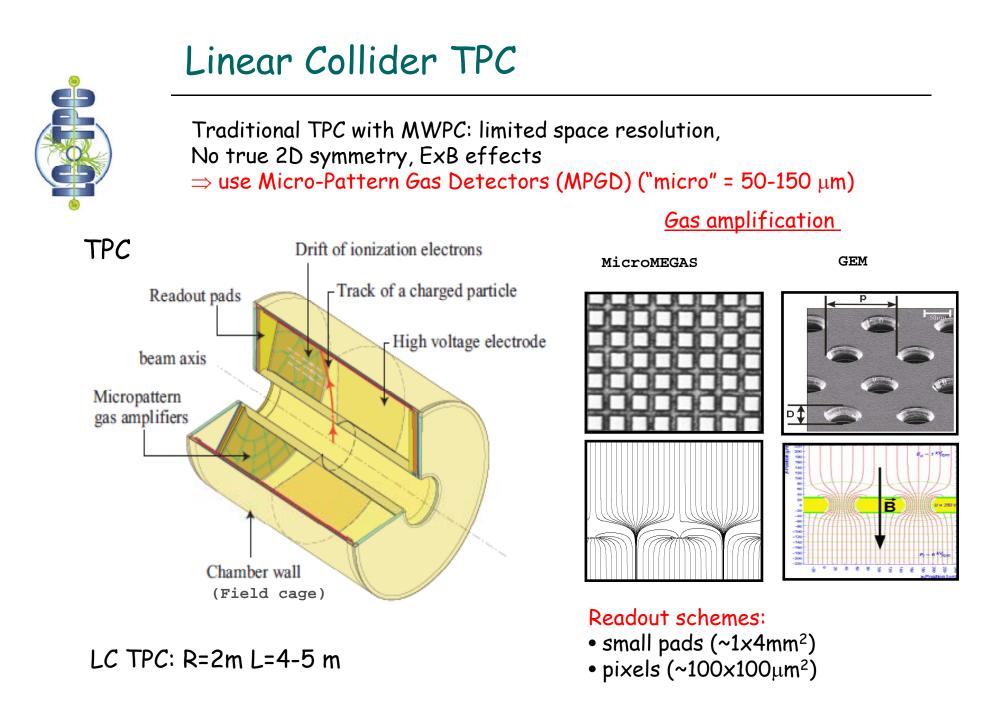
Detector Concepts for ILC



<u>SiD</u> PFA CAL. Si-Tracker (5T)

<u>4-th</u>

Compensation-Cal Gaseous tracker (also Si-?) (3.5T, double coils)





LC-TPC: Requirements

Size	Inner radius 30cm, outer radius
	158cm, length 4.32m
Momentum Resolution	$\delta(1/p_t) < 10^{-4} / \text{GeV}$
Solid angle coverage	Up to at least $ \cos\theta \le 0.98$
TPC material budget	< 0.03 X ₀ to outer fieldcage in r
	$< 0.30 X_0$ for readout endcap in z
Number of readout pads	>10 ⁶ per endcap
Pad size/ no. of padrows	About for a total of 200 pad rows
Single point resolution in r- ϕ	<~100 μm
Single point resolution in r-z	2 mm
2 track resolution in r- φ	< 2mm
2 track resolution in r-z	< 5mm
dE/dx resolution	5%
Performance robustness	Full precision/ efficiency in
	backgrounds with 10% total
	occupancy



LCTPC Collaboration

Memorandum of Agreement

on the Formation of the LCTPC Collaboration

Americas

Carleton Univ & TRIUMF, Ottawa, ON K1S 5B6, Canada Univ. de Montreal, Montreal, PQ H3C 3J7, Canada Univ. of Victoria & TRIUMF, Victoria, BC V8W 3P6, Canada Cornell Univ., Ithaca, NY 14853-5002, USA Indiana Univ., Bloomington, IN 47405, USA Lawrence Berkeley National Lab., Berkeley, CA 94720-8153, USA Louisiana Tech Univ., College of Eng.&Sience, Ruston, LA 71272, USA

Asia Tsinghua Univ., Beijing 100084, China Hiroshima Univ., Higashi-Hiroshima, Hiroshima 739-8526, Japan KEK, Tsukuba, Ibaraki 305-0801, Japan Inst. of Space&Astron.Science, Jap.Aerosp.Expl.Ag., Kanagawa 229-8510, Japan Kinki Univ., Higashi-Osaka, Osaka 577-8502, Japan Kogakuin Univ., Hachiohjii, Tokyo 192-0015, Japan Saga Univ., Faculty of Science and Engineering, Honjo, Saga 840-8502, Japan Tokyo Univ. Agriculture and Technology, Koganei, Tokyo 184-8588, Japan Univ. of Tokyo, ICEPP, Tokyo 113-0033, Japan Univ. of Tsukuba, Tsukuba, Ibaraki 305-8577, Japan Minadanao State Univ., Iigan City 9200, Philippines

Europe

IIHE (Inter-university Institute for High Energies) ULB-VUB, B-1050 Bruxelles LAL, IN2P3 and Univ. de Paris-Sud, F-91898 Orsay, France IPN, IN2P3 and Univ. de Paris-Sud, F-91405 Orsay, France CEA Saclay, DAPNIA, F-91191 Gif-sur-Yvette, France RWTH Aachen, D-52056 Aachen, Germany Univ. Bonn, D-53115 Bonn, Germany DESY Hamburg, D-22603 Hamburg, Germany EUDET, D-22603 Hamburg, Germany Albert-Ludwigs Univ., D-79104 Freiburg, Germany Univ. Hamburg, Inst. für Experimentalphysik, D-22761 Hamburg, Germany Univ. Hamburg, Inst. für Experimentalphysik, D-22761 Hamburg, Germany Univ. Karlsruhe, D-76128 Karlsruhe, Germany German Groups:

Aachen Bonn DESY Freiburg Hamburg Karlsruhe

recognized by

DESY-PRC, ILC-GDE & WWS on LC physics & detectors (periodic reviews)



LCTPC objectives

- 1. Provide a basic evaluation of the properties of an MPGD TPC and demonstrate that the requirements (at ILC) can be met using small prototypes (<u>Demonstration Phase</u>).
- Design, build and operate a "Large Prototype" (of large number of measured points) at the EUDET facility in DESY (<u>Consolidation Phase</u>).
- 3. Start working on an engineering design for aspects of the TPC at ILC (<u>Design Phase</u>).

Current major project: <u>construction of Large Prototype (LP)</u> as a common infrastructure to study major design issues on a realistic system

Start of operation planned for Summer/Fall 08 at DESY



Current Activities of D-Groups

DESY

- Coordination (hosts LP infrastructure + testbeam)
- Construction + Commissioning of LP Field Cage (EUDET)
- Slow Control
- Background Studies, Software + Simulation

Aachen

• Mobile Gas System for Testbeams, support

Bonn

- GEM+Pixel-Readout (Timepix) (EUDET)
- DAQ + Pad R/O electronics (ALTRO)
- Module Construction
- Software + Simulation

Freiburg

• GEM+Pixel-Readout (Timepix) (EUDET)

Mainz

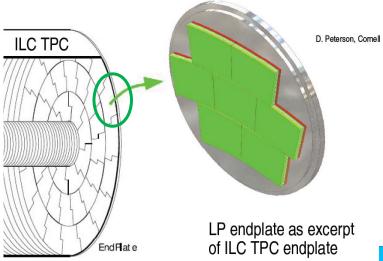
• Timepix R/O FPGA-electronics

Siegen

- Testbeam preparation (Slow Control), Prototyping Rostock
 - Pad R/O electronics (TDC development) (EUDET)
 - Slow control

The Large Prototype at DESY

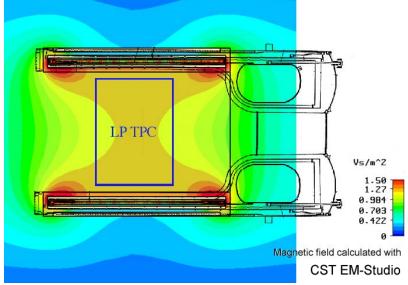




- Common prototype of 42 groups
- Drift length 60 cm
- Diameter 80 cm
- 7 exchangable modules

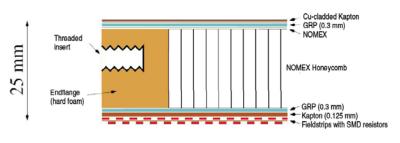
Inside solenoid with 1.25 T (PCMAG)





Fieldcage construction (DESY)

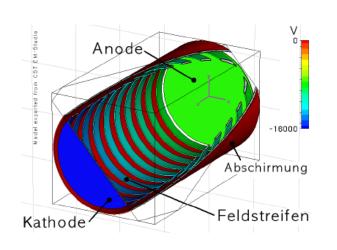
Requirements: Realistic material budget \Rightarrow Composite material

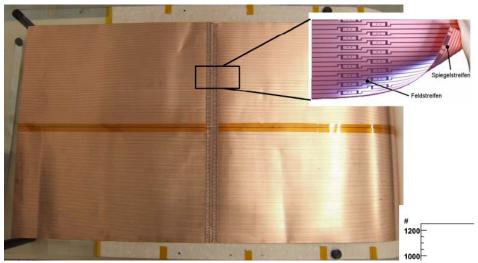




1.3% X₀

Field homogeneity < 10⁻⁴ \Rightarrow Field simulations, Field shaping



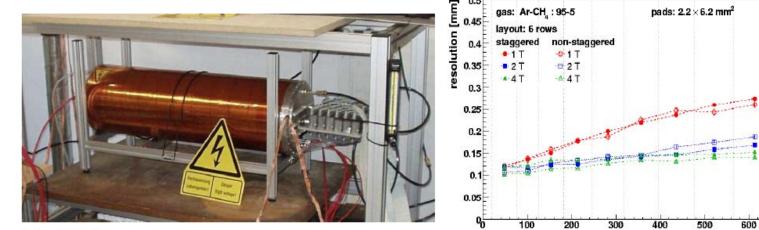


field strip foil (60x230cm²) with resistor chain



further activities DESY

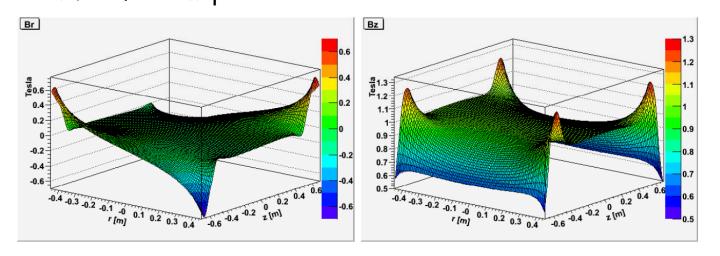
• GEM readout studies



O !

drift length [mm]

MediTPC • PCMAG field map

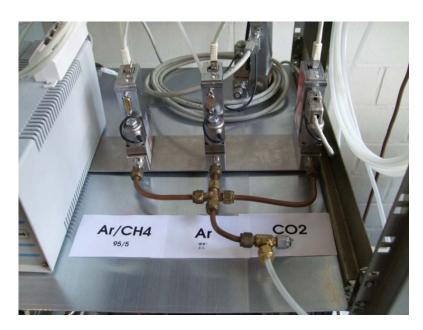




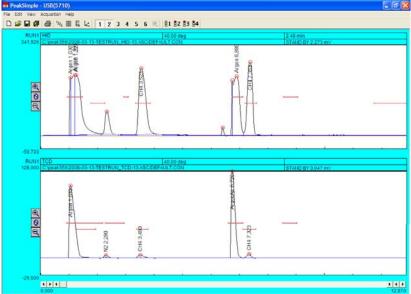
Aachen

- \cdot flexible and mobile gas system
- mixing of arbitrary gas compositions
- analysis with gas chromatograph
- currently first measurements
- later this year: construction and test





First measurements with gas chromatograph





[m]

"Pixel TPC" (Bonn, Freiburg, Mainz)

Principle: replace pad plane below MPGD structure by a CMOS Pixel-R/O Chip (no Si-detector!!!) 3-GEM+Medipix/Timepix setup pioneered at Freiburg:

x 10⁴ TOT 700 TIME 250 ₆₀₀ 2**50** 1.0525 ⁵⁰⁰ 2**00** 200 1.052 400 150 150 300 1.0515 100 100 200 1.051 50 50 100 100 150 200 100 150 200 50 250 50 250 22.06.2007_21-53-19-828_27ms 22.06.2007_21-53-19-828_27ms χ^2 / ndf 130.5 / 10 σ $\textbf{21.46} \pm \textbf{0.2545}$ Dt²/n^{el} 520.6 ± 5.789 60<u>-</u> ArCO, Results: $\langle N_{CLUSTERS} \rangle = 11$ 55 **-**• point resolution at 0 drift length: ~25 μ m 50 | 45 • studies of different GEM types 40 | • time resolution ~10ns (~300 μ m in ArCO₂) Standard GEMs 35 • ... and many more **30** 25

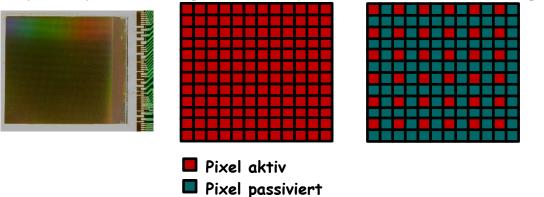
Driftlänge y

[mm]



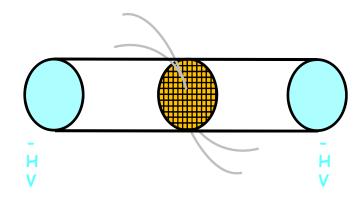
Freiburg: current + future activities

• post-processing of Timepix to combine/enlarge pixels



•N₂ laser + photocathode test (single electron eff., ion feedback)

• Simulation studies (e.g. "inverse TPC")

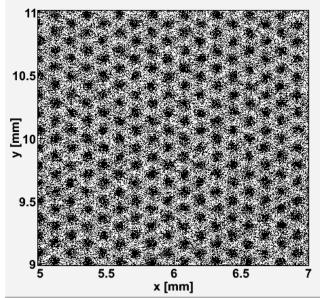




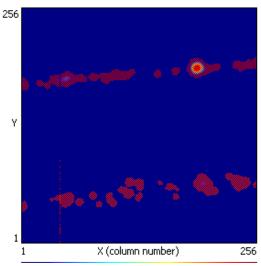
Bonn: Pixel-TPC with 25cm drift



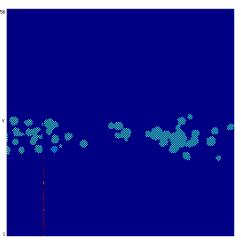
Distribution of Cluster Centres



each GEM-hole visible ⇒ proof of single-electron efficiency



double track (cosmic)

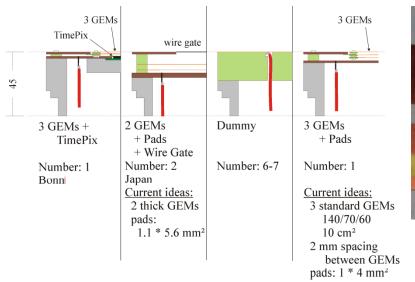


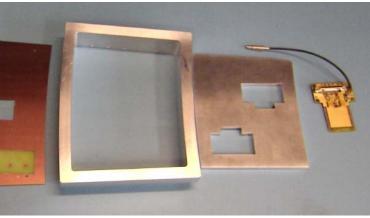
Sr source β track after ~25cm drift



Bonn: other activities

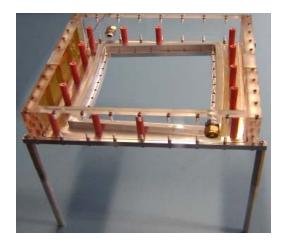
- construction of "EUDET module" (8 Timepix chips)
- pad module + dummy modules for LP





- LP module test chamber
- ALTRO electronics commissioning
- Trigger/DAQ
- Software (MarlinTPC)

Plans: contribute to design of "Timepix2" InGrid technology (within RD51 collaboration)





Mainz

(recently joined)

- FPGA-based readout-system for TimePix ("HEP-compatible")
- fast multi-chip readout
- testbeam participation

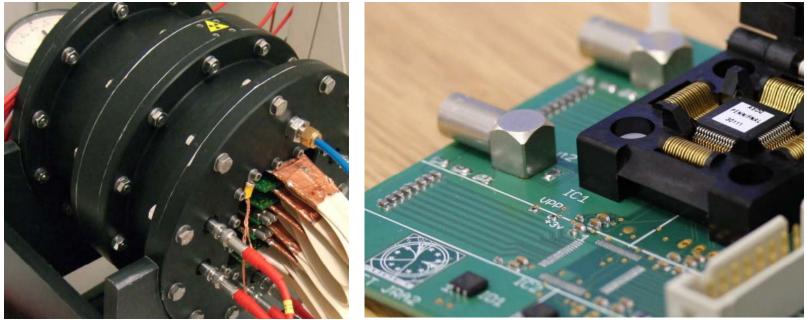
Siegen

- testbeam preparation, slow control (PhD+Bachelor student (part-time) at DESY)
- in-house prototyping, gas-system, preamp design, cosmic trigger



Rostock

- development of alternative TPC r/o electronics
- based on precise time sampling + charge-to-time conversion
- test of system with prototype board and in-house test chamber
- participation in testbeam preparation (postdoc+student at DESY)



Rostock test chamber

Test board for R/O electronics



Role of Alliance for LC-TPC (goals)

- more coherent collaboration of German groups in LC-TPC
- exchange know-how on various system aspects
- use of Alliance infrastructure:
 - testbeams
 - magnets
 - gas systems
 - (existing) r/o electronics + DAQ/trigger systems
 - benefit from chip design infrastructure for new electronics developments ("Timepix2", new electronics for pad-readout)



Summary - Conclusions

- Broad German participation + responsibility in world-wide LCTPC collaboration
- In spite of possible ILC delays well defined R&D programme
- While well focussed towards LC application, LC-TPC R&D also has a large "generic R&D" component with broader applicability (gaseous vertex detectors "GOSSIP", WIMP/Ov2β detection, Super-B?, hadron physics, X-ray polarimetry, imaging?, ...)
- Alliance can help to strengthen ties between German groups
- Benefit from Alliance infrastructure (testbeams, DESY infrastructure (magnets), chip design, mobile equipment, ...)